Very Low Leakage **Trench-based Schottky Rectifier**

Features

- Fine Lithography Trench-based Schottky Technology for Very Low Forward Voltage and Low Leakage
- Fast Switching with Exceptional Temperature Stability
- Low Power Loss and Lower Operating Temperature
- Higher Efficiency for Achieving Regulatory Compliance
- Low Thermal Resistance
- High Surge Capability
- NRV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applications

- Switching Power Supplies including Notebook / Netbook Adapters, ATX and Flat Panel Display
- High Frequency and DC–DC Converters
- Freewheeling and OR-ing Diodes
- Reverse Battery Protection
- LED Lighting
- Instrumentation

Mechanical Characteristics:

- Case: Epoxy, Molded
- Epoxy Meets Flammability Rating UL 94–0 @ 0.125 in.
- Lead Finish: 100% Matte Sn (Tin)
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Device Meets MSL 1 Requirements

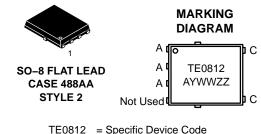


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TE0812	= Specific Device Code
А	= Assembly Location

= Assembly Location

= Year

Y

- W = Work Week
- ΖZ = Lot Traceability

ORDERING INFORMATION

Device	Package	Shipping†
NRVTS8120EMFST1G	SO–8 FL (Pb–Free)	1500 / Tape & Reel
NRVTS8120EMFST3G	SO–8 FL (Pb–Free)	5000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	120	V
Average Rectified Forward Current (Rated V_R , T_C = 163°C)	I _{F(AV)}	8.0	A
Peak Repetitive Forward Current, (Rated V _R , Square Wave, 20 kHz, T _C = 161°C)	I _{FRM}	16	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I _{FSM}	150	A
Storage Temperature Range	T _{stg}	-65 to +175	°C
Operating Junction Temperature	TJ	-55 to +175	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

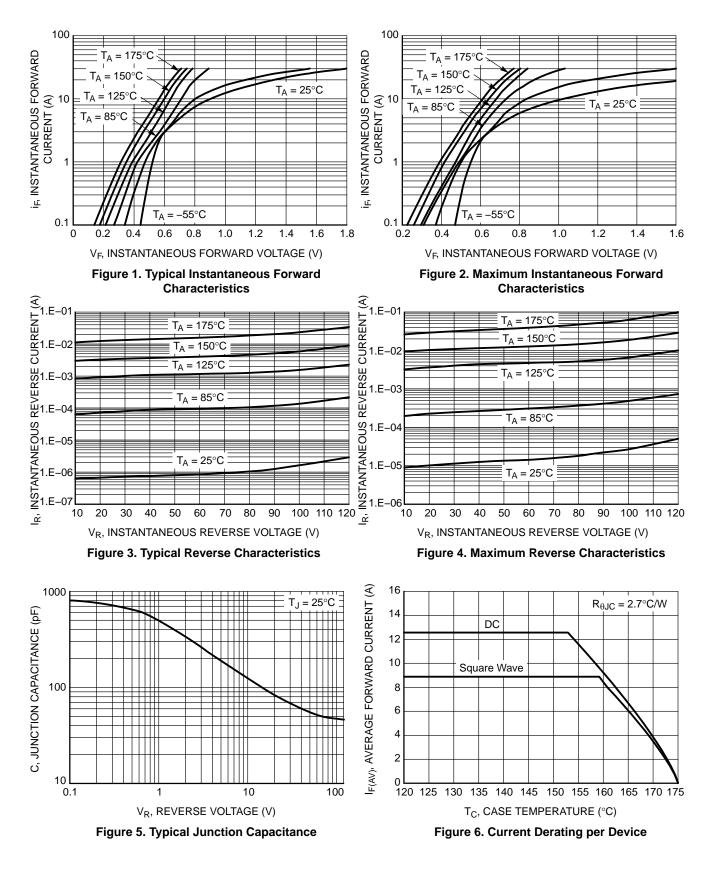
Characteristic	Symbol	Тур	Max	Unit
Thermal Resistance, Junction-to-Lead, Steady State (Assumes 600 mm ² 1 oz. copper bond pad, on a FR4 board)	$R_{ extsf{ heta}JC}$	-	2.7	°C/W

ELECTRICAL CHARACTERISTICS

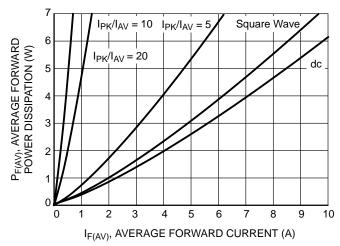
Rating	Symbol	Тур	Max	Unit
Instantaneous Forward Voltage (Note 1)	VF			V
$(I_{F} = 4 \text{ A}, T_{J} = 25^{\circ}\text{C})$		0.648	-	
$(I_F = 8 \text{ A}, T_J = 25^{\circ}\text{C})$		0.826	0.88	
(I _F = 4 A, T _J = 125°C)		0.542	_	
(I _F = 8 A, T _J = 125°C)		0.613	0.65	
Instantaneous Reverse Current (Note 1)	I _R			_
$(V_R = 90 \text{ V}, \text{T}_J = 25^{\circ}\text{C})$		1.3	-	μΑ
(Rated dc Voltage, $T_J = 25^{\circ}C$)		3.70	50	μΑ
(V _R = 90 V, T _J = 125°C)		1.4	-	mA
(Rated dc Voltage, $T_J = 125^{\circ}C$)		2.4	10	mA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 1. Pulse Test: Pulse Width = $300 \ \mu$ s, Duty Cycle $\leq 2.0\%$.

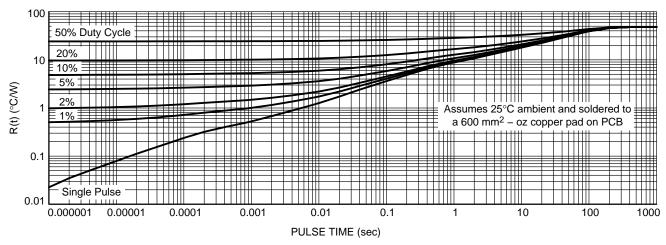
TYPICAL CHARACTERISTICS

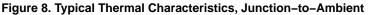


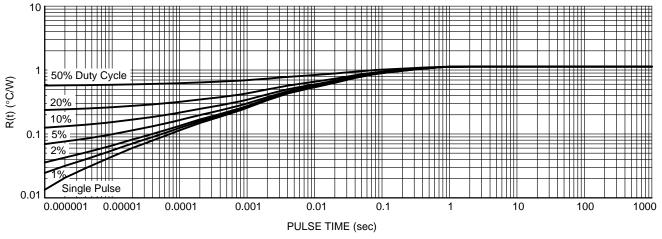
TYPICAL CHARACTERISTICS





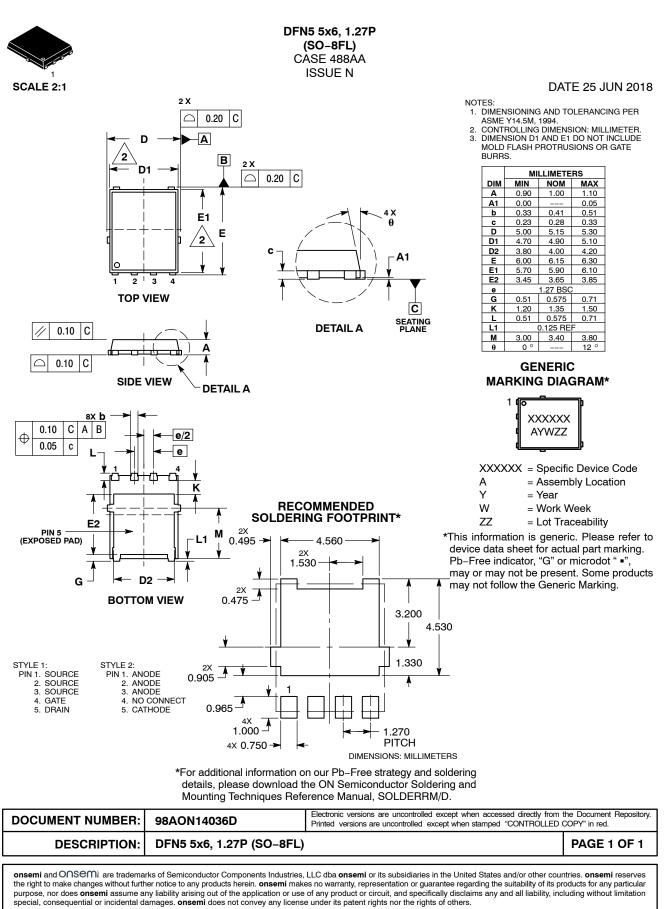








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